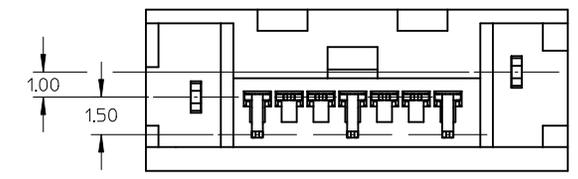
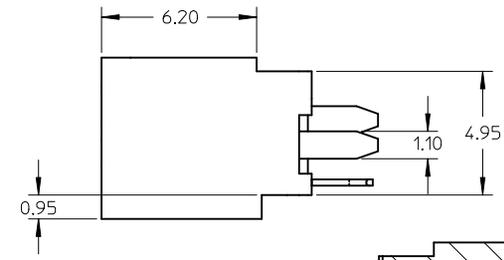
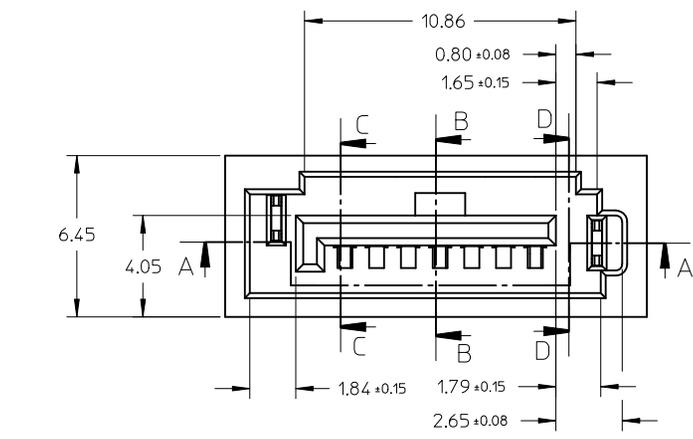
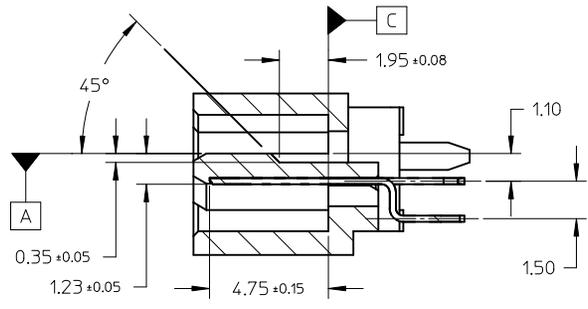


SECTION A-A

SECTION C-C

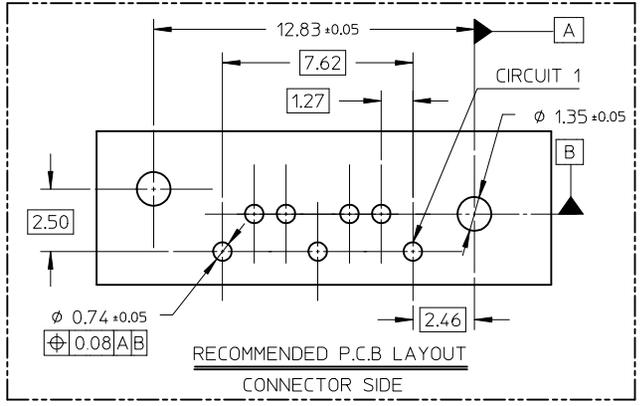


SECTION D-D



SECTION B-B

REMOVE PART NUMBER EC NO: SH2012-0062 DRWN: XQZHANG 2012/01/19 CHKD: XQZHANG 2012/01/30 APPR: AYIN 2012/02/02	QUALITY SYMBOLS $\nabla_{\text{A}}=0$ $\nabla_{\text{C}}=0$ $\nabla_{\text{F}}=0$	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 5:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION			
		4 PLACES ± --- ± ---	mm INCH	DRAWN BY GRATE MA	DATE 2004/02/02	TITLE HIGH SPEED CONNECTOR 1.27MM PITCH VERTICAL DIP SOLDER TAIL					
		3 PLACES ± --- ± ---		CHECKED BY YAJUN	DATE 2004/02/02	MOLEX INCORPORATED					
		2 PLACES ± 0.15 ± --- 1 PLACE ± 0.25 ± ---		APPROVED BY SAM	DATE 2004/02/02	MATERIAL NO. SEE SHEET 2		DOCUMENT NO. SD-67800-007	SHEET NO. 1 OF 2		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							



- NOTES:
- MATERIAL:
 - HOUSING/COLOR: SEE TABLE, GLASS FILLED, UL94V-0
 - TERMINAL/PEG: BRASS
 - TERMINAL PLATING:
 - CONTACT AREA: (a) GOLD FLASH
 - (b) GOLD, THICKNESS=0.76 MICRON MINIMUM
 - (c) GOLD, THICKNESS=0.38 MICRON MINIMUM
 - SOLDER TAIL: TIN PLATED 1.27 MICRON MINIMUM OVER NICKEL PLATED 1.27 MICRON MINIMUM
 - PEG PLATING: TIN PLATED 1.27 MICRON MINIMUM OVER NICKEL PLATED 1.8 MICRON MINIMUM
 - PACKAGING SPECIFICATION: PK-67800-001
 - PRODUCT SPECIFICATION REFER TO PS-67491-001
 - RECOMMENDED SOLDERING PROCESS:
 - THERMAL PLASTIC FOR WAVE SOLDERING PROCESS
 - HIGH TEMPERATURE THERMAL PLASTIC FOR IR SOLDERING PROCESS

PART NUMBER	PLATING TYPE	DIM A	DIM B	P.C.B THICKNESS	PLASTIC TYPE	PLASTIC COLOR	REMARK
67800-7055	SEE NOTE2(c)						
67800-7052	SEE NOTE2(b)	2.85	3.05	2.00±0.05	THERMAL PLASTIC	NATURE	
67800-7051	SEE NOTE2(a)						
67800-7045	SEE NOTE2(c)	2.45	2.65	1.60±0.05			
67800-7042	SEE NOTE2(b)						
67800-7082	SEE NOTE2(b)	3.25	3.45	2.40±0.05			
67800-7075	SEE NOTE2(c)						
67800-7072	SEE NOTE2(b)	2.85	3.05	2.00±0.05	THERMAL PLASTIC	PROCESS BLUE C	
67800-7071	SEE NOTE2(a)					ΔE<3	
67800-7035	SEE NOTE2(c)	2.45	2.65	1.60±0.05			
67800-7031	SEE NOTE2(a)						
67800-7025	SEE NOTE2(c)						
67800-7022	SEE NOTE2(b)	3.25	3.45	2.40±0.05			PURE TIN
67800-7021	SEE NOTE2(a)						
67800-7015	SEE NOTE2(c)	2.85	3.05	2.00±0.05	THERMAL PLASTIC	BLACK	
67800-7011	SEE NOTE2(a)						
67800-7005	SEE NOTE2(c)						
67800-7002	SEE NOTE2(b)	2.45	2.65	1.60±0.05			
67800-7001	SEE NOTE2(a)						
67800-7115	SEE NOTE2(c)	2.85	3.05	2.00±0.05	HIGH TEMPERATURE	BLACK	
67800-7111	SEE NOTE2(a)						
67800-7105	SEE NOTE2(c)	2.45	2.65	1.60±0.05	THERMAL PLASTIC		
67800-7102	SEE NOTE2(b)						

SEE SHEET 1 EC NO: SH2012-0062 DRWN: XZZHANG 2012/01/19 CHKD: XZZHANG 2012/01/30 APPR: AYIN 2012/02/02	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
	▽ _A =0	mm INCH	MM ONLY	5:1	METRIC	
	▽ _B =0	4 PLACES ± --- ± ---	DRAWN BY DATE			
	▽ _C =0	3 PLACES ± --- ± ---	GRATE MA 2004/02/02			
▽ _D =0	2 PLACES ± 0.15 ± ---	CHECKED BY DATE				HIGH SPEED CONNECTOR 1.27MM PITCH VERTICAL DIP SOLDER TAIL
	1 PLACE ± 0.25 ± ---	YA JUN 2004/02/02				
	ANGULAR ± 1/2°	APPROVED BY DATE				MOLEX INCORPORATED SD-67800-007
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	SAM 2004/02/02				
		MATERIAL NO.	SEE TABLE			DOCUMENT NO.
			SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		SHEET NO.
						2 OF 2